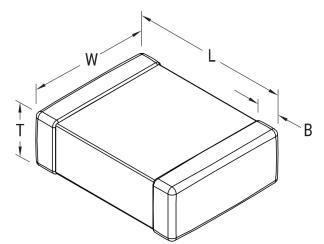


C1210C104K2RAC7210

SMD Comm X7R, Ceramic, 0.1 uF, 10%, 200 VDC, X7R, SMD, MLCC, Temperature Stable, Class II, 1210



Click here for the 3D model.

Dimensions		
Chip Size	1210	
L	3.2mm +/-0.2mm	
W	2.5mm +/-0.2mm	
Т	1.25mm +/-0.15mm	
В	0.5mm +/-0.25mm	

Packaging Specifications	
Packaging	T&R, 330mm, Plastic Tape
Packaging Quantity	10000
5 5 ,	

General Information	
Series	SMD Comm X7R
Style	SMD Chip
Description	SMD, MLCC, Temperature Stable, Class II
Features	Temperature Stable, Class II
RoHS	Yes
Termination	Tin
Marking	No
AEC-Q200	No
Component Weight	65 mg
Shelf Life	78 Weeks
MSL	1

Specifications	
Capacitance	0.1 uF
Measurement Condition	1 kHz 1.0Vrms
Capacitance Tolerance	10%
Voltage DC	200 VDC
Dielectric Withstanding Voltage	500 VDC
Temperature Range	-55/+125°C
Temperature Coefficient	X7R
Capacitance Change with Reference to +25°C and 0 VDC Applied (TCC)	15%, 1kHz 1.0Vrms
Dissipation Factor	2.5% 1 kHz 1.0Vrms
Aging Rate	3% Loss/Decade Hour: Referee Time is 1000 Hours
Insulation Resistance	10 GOhms

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